



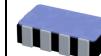
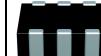
Ceramic transient voltage suppressors

Selector guide

Date: November 2010

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Selector guide

Design	Technology	Construction	Case size	Terminals	Code		Page		
Multilayer varistors (MLVs)									
SMD	Multilayer	Single chip	0201, 0402, 0603, 0805, 1206, 1210, 1812, 2220	Nickel barrier metallization	CT				
				Silver-palladium metallization	CN				
				Silver-platinum metallization	CN... K2				
		2-fold array	0405	Nickel barrier metallization	CA				
		4-fold array	0508, 0612						
ESD/EMI filters									
SMD	Multilayer	2-fold array with common ground		0405	Nickel barrier metallization	CA	 		
		4-fold array with common ground		0508					
CeraDiodes									
SMD	Multilayer	Single chip	0201, 0402, 0603, 1003	Nickel barrier metallization	CDS	  			
		4-fold array	0508, 0612	Nickel barrier metallization	CDA				
		2/4 data + 1 supply array	0506, 1012						
SMD disk varistors (CU varistors)									
SMD	Monolithic	Disk varistor element with thermoplast encapsulation	3225, 4032	Tinned copper alloy	CU				
Leaded transient voltage/RFI suppressors (SHCVs)									
Leaded	Multilayer	Multilayer varistor plus multilayer capacitor	SR1, SR2, SR6	Tinned iron wire	SR				